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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

William E. Bernier et al.

Serial No.: To be assigned

Art Unit: To be assigned

Filed: Herewith

Examiner: To be assigned

For: SOLDER PROTECTIVE
COATING AND FLUXLESS
JOINING OF FLIP CHIP
DEVICES ON LAMINATES
WITH PLATED SOLDER

Atty Docket: 0135/00311

#2
12-29-00

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Listed on accompanying form PTO-1449 are a number of documents which may be considered relevant to the examination of this application. A copy of each of these documents is provided. It is respectfully requested that the Examiner initial and return a copy of the enclosed PTO-1449, and indicate in the official file wrapper of this patent application that the documents have been considered.

Respectfully submitted,



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